



## USFDA, CONEG AND TAPPI COMPLIANCE 04/01/2024

Products used in the preparation of our products as manufactured by TenCorr Packaging Inc. are without exception in compliance with US**FDA regulations** for use in food paperboard applications under Title 21, sections 176.170 and 170.180 and Federal Food, Drug and Cosmetic Act under the provisions of Sections 404, 405 and 512.

Our current manufacturers confirm their products do not contain any of the chemicals on the most current **California Proposition 65** list and have certified all products used in the preparation of their containerboard.

The paper used in our process has been tested for all metal listed on the **CONEG model and Reach European Standards for Substances of Very high concern legislation**. Results indicate insignificant levels even when compared to the most stringent part of the legislation (1994 standard). Therefore we can report no substances exist in the paper used in our processes.

## The starch and water we use for the making of adhesive is a food grade cornstarch and meets FDA and CFIA standards for food contact.

Cadmium, hexavalent chromium, lead and mercury are not intentionally used in our linerboard and medium. The sum of the incidental concentrations of cadmium, hexavalent chromium, lead and mercury in any such packaging component shall not exceed 100 parts per million (ppm). Indeed, elemental analyses of representative linerboard found none at analytical detection sensitivities of 1 ppm for mercury, 2ppm for cadmium and lead, and 10 ppm for chromium.

## The paper does not contain dimethylfumarate (DMF).

All packaging and packaging components are subject to these "heavy metal" restrictions.

**21 CRF 801.437 (b)** No Natural Rubber or Latex is used whatsoever in the manufacturing of corrugated sheet stock in either of our manufacturing facilities.

Our products are manufactured and warranted **to Tappi Standard T811 OM-88** Edge wise compressive strength of corrugated paper.

**Rohs/Reach and WEEE compliance**. These directives apply solely to electrical and electronic equipment and not the packaging itself.

**Dodd-Frank Conflict Minerals compliance.** No gold, tin, tungsten and tantalum minerals are present or used in our products whatsoever.

TenCorr Packaging Inc. Royal Containers Ltd.

CERTIFIED BY: Martin Todd Director of Quality/Safety

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